HT10000 Thermal Conductive Gap Filler

BENEFITS AND FEATURES

- High thermal performance
- Low contact resistance
- Easily dispensable and reworkable
- Excellent gap-filling capability
- Naturally tacky
- · Low oil bleeding

OVERVIEW

Honeywell HT10000 one-part Gap Filler provides an effective thermal properties and high conformability with its high compressibility. It is formulated to deliver high dispense rates for improved productivity, long-term reliability performance and easy reworkable. It is designed to minimize thermal resistance at interfaces, maintain excellent performance through reliability testing.

TYPICAL APPLICATIONS

- Consumer electronics
- Telecommunications equipment
- Automotive electronics
- Power supplies & semiconductors
- Memory & power modules
- Power electronics

STORAGE & USE

 Shelf life 12 months at 0-35°C, ≤65% RH

Property	HT10000	Test Method
Feature	Silicone-based	-
	Pre-cured	-
Color	Dark grey	Visual
Thermal Conductivity (W/m·K)	10.0	ASTM D5470
Thermal Impedance (°C.In²/W)	0.16	ASTM D5470
(1mm@10psi, Typical Value)	0.10	
Dispense Rate (g/min)	15	90psi, 30cc EFD syringe
Density(g/cm³)	3.22	ASTM D792
Volatile Content (TML%)	<0.4	HON Internal

^{*}Typical property data values should not be used as specifications

Honeywell Electronic Materials

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